# PRODUCT CHANGE NOTICE

## Alternate Manufacturing Facility for Assembly of the Listed Intersil QFN/TQFN Packaged Products

Refer to: PCN14021

Date: March 27, 2014

**intersil** SIMPLY SMARTER<sup>™</sup>

#### March 27, 2014

#### To: Our Valued Intersil Customer

#### Subject: Alternate Manufacturing Facility for Assembly of the Listed Intersil QFN/TQFN Packaged Products – Advanced Semiconductor Engineering (ASECL) - Chung-Li, Taiwan

This notice is to inform you that Intersil will begin using the Advanced Semiconductor Engineering (ASECL) facility as alternate site for assembly of the listed QFN/TQFN (Quad Flat No-Lead/Thin Quad Flat No-Lead) packaged products. The current facility STATS ChipPAC (SCM) located in Kuala Lumpur, Malaysia has officially announced plant closure by end of year 2014. The hyperlink to the announcement is <a href="http://www.statschippac.com/news/newscenter/2013/news06282013.aspx">http://www.statschippac.com/news/newscenter/2013/news06282013.aspx</a>. As of the date of this notice, the product and site-specific qualification activities at the Advanced Semiconductor Engineering (ASECL) facility are complete.

The Advanced Semiconductor Engineering (ASECL) facility is ISO 9001:2008 and ISO/TS 16949:2009 certified. ASECL is qualified as a primary supplier to Intersil for high volume assembly of QFN/TQFN packaged products. There is no change in the MSL (moisture sensitivity level) or POD (package outline drawing).

The assembly qualification plan is designed using JEDEC and other applicable industry standards to confirm there is no impact to form, fit, function, or interchangeability of the product. A summary of the qualification results are included for reference. The remainder of the manufacturing operations (wafer fabrication, package level electrical testing, etc.) will continue to be processed to previously established conditions and systems.

Product affected by this change is identifiable via Intersil's internal traceability system. In addition, product assembled at ASECL may also be identified by the assembly site code (country of assembly) when marked on the devices. The site code for the listed products assembled at ASECL is "W".

Intersil will take all necessary actions to conform to agreed upon customer requirements and to ensure the continued high quality and reliability of Intersil products being supplied. Customers may expect to receive product assembled at the SCM or ASECL facility beginning *ninety* days from the date of this notification or earlier with approval.

If you have concerns with this change notice, Intersil must hear from you promptly. Please contact the nearest Intersil Sales Office or call the Intersil Corporate line at 1-888-468-3774, in the United States, or 1-321-724-7143 outside of the United States.

Regards,

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Jeff Touvell Intersil Corporation

PCN14021

CC: D. Decrosta S. Nadarajah S. Ang C. Brazil T. Linder



## PCN14021 – ASECL Reliability Qualification Results

Stress / Conditions	Duration	ISL8016IR12Z 20 lead QFN	ISL8077IRTAJZ 16 lead QFN
Moisture Sensitivity Classification		N = 22 Acc = 0 L3 PBFREE	N = 22 Acc = 0 L3 PBFREE
High Temperature Operating	1000 Hrs	N = 235	N = 80
+ 125°C		Acc = 0	Acc = 0
Biased HAST	96 Hrs	N = 234	N = 234
+130C / 85% RH		Acc = 0	Acc = 0
Temp Cycle	500 Cy	N = 234	N = 234
+150C / -65C		Acc = 0	Acc = 0
High Temperature Storage	1000 Hrs	N = 234	N = 234
T <sub>A</sub> = +150C		Acc = 0	Acc = 0

Qualification by Extension Qualification Completed & Passed

### PCN14021 - Affected Products (ASECL)

ISL8016IRAJZ ISL8016IRAJZR5615 ISL8016IRAJZ-T ISL8016IRAJZ-T7A ISL8016IRAJZT7AR5615 ISL8016IRAJZ-TR5615 ISL8016IRAJZ-TS2490 ISL8023AIRTAJZ ISL8023AIRTAJZ-T ISL8023AIRTAJZ-T7A ISL8023IRTAJZ ISL8023IRTAJZR5194 ISL8023IRTAJZ-T ISL8023IRTAJZ-T7 ISL8023IRTAJZ-T7A ISL8023IRTAJZ-TR5194 ISL8023IRTAJZ-TS2568 ISL8023IRTAJZ-TS2705 ISL8024AIRTAJZ ISL8024AIRTAJZ-T ISL8024AIRTAJZ-T7A ISL8024IRTAJZ-TS2568 ISL8077IRTAJZS2765 ISL8077IRTAJZ-TS2765

